



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20160823006
Datasheet update for SN54HC132, SN74HC132
Information Only Datasheet**

Date: 9/1/2016
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

20160823006
Information Only Datasheet
Attachments


Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
SN74HC132N	null
SN74HC132NSR	null
SN74HC132PWR	null

Technical details of this Product Change follow on the next page(s).

Notification Number:	20160823006	Notification Date:	Sept. 1, 2016
Title:	Datasheet update for SN54HC132, SN74HC132		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

Notification Details											
Description of Change:											
Texas Instruments Incorporated is announcing an information only notification.											
The product datasheet(s) is being updated as summarized below.											
The following change history provides further details.											
<div style="display: flex; justify-content: space-between; align-items: flex-start;"> <div style="text-align: center;">  </div> <div style="text-align: right;"> SN54HC132 SN74HC132 <small>SCLS034G – DECEMBER 1982 – REVISED JUNE 2016</small> </div> </div> <hr/> <table border="0" style="width: 100%;"> <tr> <td style="width: 80%;">Changes from Revision F (November 2004) to Revision G</td> <td style="width: 20%; text-align: right;">Page</td> </tr> <tr> <td> <ul style="list-style-type: none"> Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section. Removed Ordering Information table, see POA at the end of the data sheet. </td> <td style="text-align: right; vertical-align: bottom;"> 1 1 </td> </tr> </table> <p>The datasheet number will be changing.</p> <table border="1" style="width: 100%;"> <tr> <td>Device Family</td> <td>Change From:</td> <td>Change To:</td> </tr> <tr> <td>SN54HC132, SN74HC132</td> <td>SCLS034F</td> <td>SCLS034G</td> </tr> </table> <p>These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/SN74HC132</p>		Changes from Revision F (November 2004) to Revision G	Page	<ul style="list-style-type: none"> Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section. Removed Ordering Information table, see POA at the end of the data sheet. 	1 1	Device Family	Change From:	Change To:	SN54HC132, SN74HC132	SCLS034F	SCLS034G
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Device Family	Change From:	Change To:									
SN54HC132, SN74HC132	SCLS034F	SCLS034G									

Reason for Change:			
To more accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.			
Changes to product identification resulting from this PCN:			
None.			
Product Affected:			
SN74HC132D	SN74HC132DRG4	SN74HC132NSRE4	SN74HC132PWR
SN74HC132DBR	SN74HC132DT	SN74HC132NSRG4	SN74HC132PWRE4
SN74HC132DBRG4	SN74HC132DTE4	SN74HC132PW	SN74HC132PWRG4
SN74HC132DE4	SN74HC132N	SN74HC132PWE4	SN74HC132PWT
SN74HC132DG4	SN74HC132NE4	SN74HC132PWG4	SN74HC132PWTE4
SN74HC132DR	SN74HC132NSR	SN74HC132PWLE	SN74HC132PWTG4
SN74HC132DRE4			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com